PRELIMINARY PRODUCT INFORMATION

CEL

BIPOLAR ANALOG INTEGRATED CIRCUIT

μPC8233TK

SiGe:C LOW NOISE AMPLIFIER FOR GPS/MOBILE COMMUNICATIONS

DESCRIPTION

The μPC8233TK is a silicon germanium carbon (SiGe:C) monolithic integrated circuit designed as low noise amplifier for GPS and mobile communications. This device exhibits low noise figure and high power gain characteristics. This device is suitable for the reduction in power consumption of the mobile communication system because it operates by low voltage and low current.

The package is 6-pin lead-less minimold, suitable for surface mount.

This IC is manufactured using our UHS4 (Ultra High Speed Process) SiGe:C bipolar process.

FEATURES

- Supply voltage : V_{CC} = 1.7 to 3.3 V (2.7 V TYP.)
- Low noise : NF = 0.90 dB TYP. @ V_{CC} = 2.7 V, f_{in} = 1575 MHz
  NF = 0.90 dB TYP. @ V_{CC} = 1.8 V, f_{in} = 1575 MHz
- High gain : G_P = 20 dB TYP. @ V_{CC} = 2.7 V, f_{in} = 1575 MHz
  G_P = 19.5 dB TYP. @ V_{CC} = 1.8 V, f_{in} = 1575 MHz
- Low current consumption : I_{CC} = 3.5 mA TYP. @ V_{CC} = 2.7 V
- Built-in power-saving function V_{PSon} = 1.0V to Vcc V_{PSoff} = 0.0 to 0.4V
- High-density surface mounting : 6-pin lead-less minimold package (1.5 × 1.1 × 0.55 mm)
- Included very robust bandgap regulator (Small V_{CC} and T_A dependence)
- Included protection circuits for ESD

APPLICATION

- Low noise amplifier for GPS and mobile communications

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPC8233TK-E2	μPC8233TK-E2-A	6-pin lead-less minimold (1511 PKG) (Pb-Free)	TBD	• 8 mm wide embossed taping • Pin 1, 6 face the perforation side of the tape • Qty 5 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μPC8233TK

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

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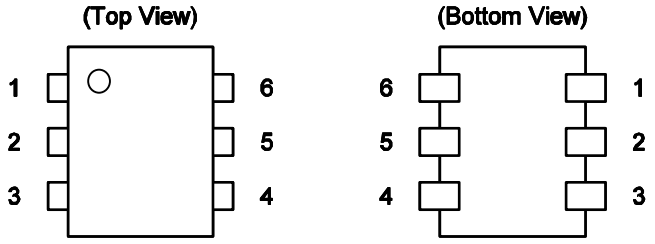
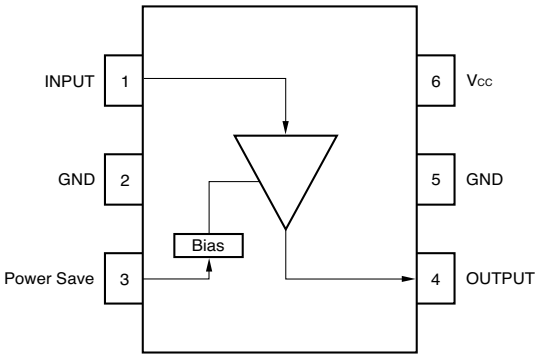
PIN CONNECTIONS



Pin No.	Pin Name
1	INPUT
2	GND
3	Power Save
4	OUTPUT
5	GND
6	V_{CC}

INTERNAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	V_{CC}	T_A = +25°C	4.0	V
Power-Saving Voltage	V_{PS}	T_A = +25°C	4.0	V
Power Dissipation	P_D	T_A = +85°C **Note**	232	mW
Operating Ambient Temperature	T_A		–40 to +85	°C
Storage Temperature	T_{stg}		–55 to +150	°C
Input Power	P_{in}		+10	dBm

Note Mounted on double-side copper-clad 50 × 50 × 1.6 mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V_{CC}	1.7	2.7	3.3	V
Operating Ambient Temperature	T_A	–40	+25	+85	°C
Power Save Turn-on Voltage	V_{PSon}	1.0	–	V_{CC}	V
Power Save Turn-off Voltage	V_{PSoff}	0	–	0.4	V

ELECTRICAL CHARACTERISTICS

(T_A = +25°C, V_{CC} = V_{PS} = 2.7 V, f_{in} = 1575 MHz, unless otherwise specified)

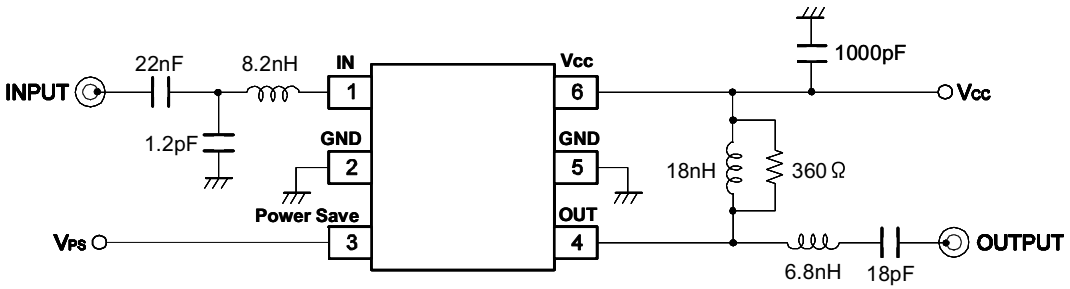
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I_{CC}	No Signal (V_{PS} = 2.7 V)	2.5	3.5	4.8	mA
		At Power-Saving Mode (V_{PS} = 0 V)	–	–	1	μA
Power Gain	G_P	P_{in} = –35 dBm	17.5	20	22.5	dB
Noise Figure	NF		–	0.9	1.2	dB
Input 3rd Order Distortion Intercept Point	IIP_3	$f_{in}1$ = 1574 MHz, $f_{in}2$ = 1575 MHz	–	–7.5	–	dBm
Input Return Loss	RL_{in}		7	16	–	dB
Output Return Loss	RL_{out}		8	16	–	dB
Isolation	ISL		–	36	–	dB
Gain 1 dB Compression Input Power	$P_{in\ (1\ dB)}$		–	–23	–	dBm

STANDARD CHARACTERISTICS FOR REFERENCE

(T_A = +25°C, V_{CC} = V_{PS} = 1.8 V, f_{in} = 1575 MHz, unless otherwise specified)

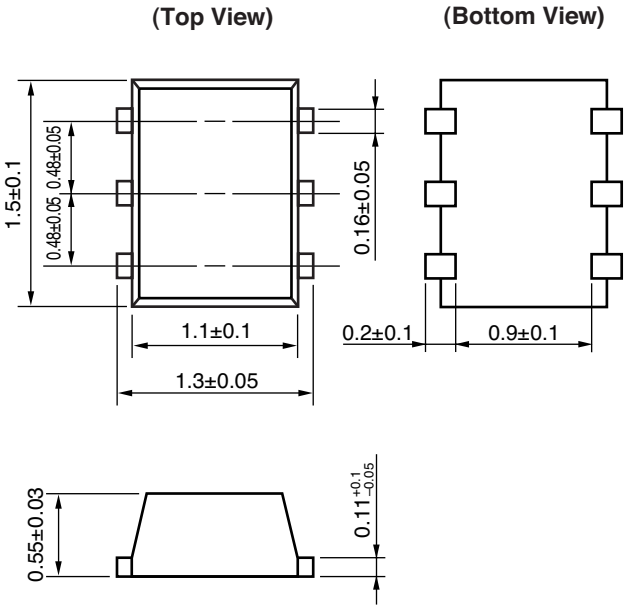
Parameter	Symbol	Test Conditions	Reference	Unit
Circuit Current	I_{CC}	No Signal (V_{PS} = 1.8 V)	3.3	mA
		At Power-Saving Mode (V_{PS} = 0 V)	–	μA
Power Gain	G_P	P_{in} = –35 dBm	19.5	dB
Noise Figure	NF		0.9	dB
Input 3rd Order Distortion Intercept Point	IIP_3	$f_{in}1$ = 1574 MHz, $f_{in}2$ = 1575 MHz	–8	dBm
Input Return Loss	RL_{in}		16	dB
Output Return Loss	RL_{out}		15.5	dB
Isolation	ISL		36	dB
Gain 1 dB Compression Input Power	$P_{in\ (1\ dB)}$		–23.5	dBm

TEST CIRCUIT



PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511 PKG) (UNIT: mm)



NOTES ON CORRECT USE

(1) Observe precautions for handling because of electro-static sensitive devices.

(2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.

(3) The bypass capacitor should be attached to V_{CC} line.

(4) Do not supply DC voltage to INPUT pin.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Wave Soldering	Peak temperature (molten solder temperature)	: 260°C or below	WS260
	Time at peak temperature	: 10 seconds or less	
	Preheating temperature (package surface temperature)	: 120°C or below	
	Maximum number of flow processes	: 1 time	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

Caution Do not use different soldering methods together (except for partial heating).

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  "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

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M8E 02. 11-1

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A	-AZ
		Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.